City University of Hong Kong  
City-EE Student Exchange Scholarship

(1) Eligibility and Requirements  
(i) Students of the UGC funded programmes offered by the Department of Electronic Engineering are eligible to apply and the minimum requirements are as follows:

- Local students should have (i) achieved a minimum CGPA of 2.5 at the time of application; (ii) successfully obtained a place for an exchange programme; and (iii) fulfilled the language requirement of the University AND the host institution.

- Non-local students should have (i) achieved a minimum CGPA of 3.5 at the time of application; (ii) successfully obtained a place for an exchange programme; and (iii) fulfilled the language requirement of the University AND the host institution.

(ii) Scholarship recipients are required to (i) take no less than 12 credits or equivalent on exchange; (ii) satisfactorily complete the exchange programme; and (iii) resume studies at CityU in the semester immediately following the exchange (except for those joining the exchange in their final semester). Failure to fulfill these requirements will result in the withdrawal of the scholarship.

(2) Amount  
The value of each scholarship shall range from HK$2,000 to HK$15,000, depending on the applicants’ academic performance and the country where the exchange programme will take place.

(3) Obligation of the scholarship recipients  
Scholarship recipients are required to be CityU-EE’s student exchange ambassadors. They are expected to promote the image of the University and Department in the host institutions. On their return, they are required to (i) provide an exchange blog for sharing their experience with fellow students; and (ii) be advisors for future exchange students.

(4) Application Procedures and Deadlines  
Students who have received an exchange offer may submit application for the scholarship to the EE General Office by:

- Main Round – end of March (result available in early April)
- Clearing Round – end of October (result available in early November)

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Application Form

Name of Applicant:  

Results of TOEFL or IELTS  
Please attach copy of the result slip. If the result is not available at the time of application, please provide as soon as available.

I understand the requirements and obligations for the recipients of this scholarship as stipulated above. I undertake to reimburse the full cost of the scholarship to the Department of Electronic Engineering of the City University of Hong Kong if I fail to fulfill the requirements specified in Paragraph (1)-(ii) above.

Signature: __________________________  Date: __________________________